

# nSMD050-13.2V

# Performance Specification

Mode	Marking	V <sub>max</sub>	max	I <sub>hold</sub>	I <sub>trip</sub>	$\mathbf{P}_{d}$	Maximum Time To Trip		Resistance		Agency Approval	
MOGE	ii Marking	(Vdc)	(A)	@25°C (A)	@25°C (A)	Max. (W)	Current (A)	Time (Sec)	Ri <sub>min</sub> (Ω)	R1max (Ω)	UL	TUV
nSMD0	<b>50</b> α F	13.2	100	0.50	1.00	0.6	8.00	0.10	0.150	0.700	$\checkmark$	
Ihold = Hold	hold = Hold Current. Maximum current device will not trip in 25°C still air.											
Itrip = Trip (	ip = Trip Current. Minimum current at which the device will always trip in 25°C still air.											
Vmax = Max	/max = Maximum operating voltage device can withstand without damage at rated current (Imax).											
Imax = Max	nax = Maximum fault current device can withstand without damage at rated voltage (Vmax).											
Pd = Powe	<b>Pd</b> = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.											
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.												
R1 <sub>max</sub> = Maximum device resistance is measured one hour post reflow.												
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.												

# **Environmental Specifications**

Test	Conditions	Resistance change					
Passive aging	+85°C, 1000 hrs.	±5% typical					
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical					
Thermal shock	+85°C to -40°C, 20 times	±33% typical					
Resistance to solvent	MIL-STD-202, Method 215	No change					
Vibration	MIL-STD-202, Method 201	No change					
Ambient operating conditions :	- 40 °C to 85 °C						
Maximum surface temperature of the device in the tripped state is 125 °C							

Agency Approvals :



E201504(Alpha-Top)/E319079

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Regulation/Standard:



2002/95/EC

EN14582

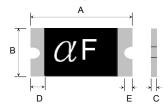
Ihold Versus Temperature

	Model	Maximum ambient operating temperature $(T_{mao})$ vs. hold current $(I_{hold})$									
	Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C	
	nSMD050	0.71	0.64	0.57	0.50	0.42	0.39	0.35	0.31	0.25	

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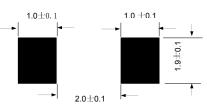
Construction And Dimension (Unit:mm)											
Model	l l	4		В		С		E			
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.			
nSMD050	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10			

#### **Dimensions & Marking**



 $\alpha$  = Trademark F = Part identification

### **Recommended Pad Layout (mm)**



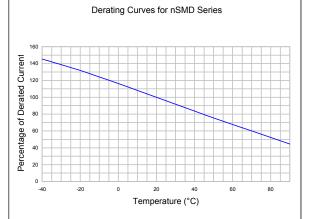
## **Termination Pad Characteristics**

Terminal pad materials : Terminal pad solderability : Rework

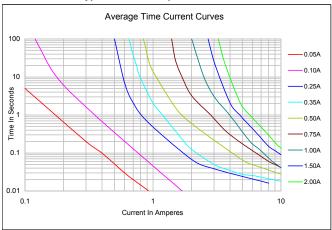
Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Use standard industry practices, the removal device must be replaced with a fresh one.

## **Thermal Derating Curve**



# Typical Time-To-Trip At 25°C



# WARNING:

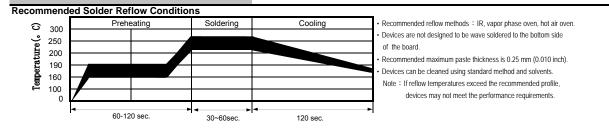
Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

- DPTC are intended for protection against occasional over current or were magnetate possible conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
  Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

Avoid inpact PPTC device its thermal expansion like placed under pressure or installed in limited space. • Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods. Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

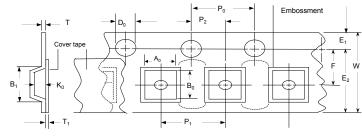
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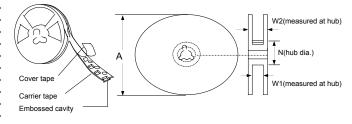
# Tape And Reel Specifications (mm)

W	8.15 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	$2.0 \pm 0.05$
_A0	1.95 ± 0.10
B0	3.45 ± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0
F	3.5 ± 0.05
<u>E1</u>	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
<u>K0</u>	1.04 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
<u>W1</u>	9 ± 0.5
W2	12.6 ± 0.5

# **EIA Tape Component Dimensions**



# **EIA Reel Dimensions**



Storage And Handling • Storage conditions : 40°C max, 70% R.H.

 Devices may not meet specified performance if storage conditions are exceeded.

Order Information	Packaging					
nSMD	'050	-13.2V	Tape & Reel Quantity			
Product name	Hold	Max				
Size 3216 mm / 1206 inch	Current	Voltage	5,000 pcs/reel			
SMD : surface mount device	0.50A					